



2 CHANNEL LOW CAPACITANCE TVS DIODE ARRAY

Product Summary

V _{BR (min)}	I _{PP (max)}	C _{T (typ)}
6V	7.5A	0.8pF

Description

The DUSBULC6-CSP4 is a high-performance device suitable for protecting two high speed I/Os. These devices are assembled in CSP packages and have high ESD surge capability and low capacitance.

Applications

Typically used at high-speed ports such as USB 2.0, IEEE1394 (Firewire®, iLink™), Serial ATA, DVI, HDMI, PCI.

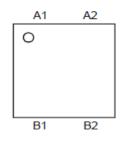
Features

- IEC 61000-4-2 (ESD): Air ±15kV, Contact ±15kV
- Low Channel Input Capacitance of 1.2pF Max
- 2 Channel of ESD Protection
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

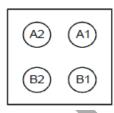
Mechanical Data

- Case: W-WLB0808-4
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram
- Weight: 0.001 grams (Approximate)

W-WLB0808-4

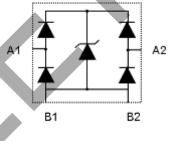






Bottom View

Pin Configuration



Device Schematic

Ordering Information (Note 4)

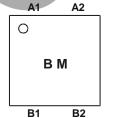
Product	Compliance	Marking	Reel Size (inches)	Tape Width (mm)	Quantity per Reel
DUSBULC6-CSP4-7	Standard	BM	7	8	3,000/Tape & Reel
DUSBULC6-CSP4-7B	Standard	BM	7	8	10,000/Tape & Reel

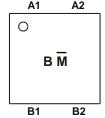
Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information

W-WLB0808-4





B = Product Type Marking Code M = Month Marking Code (ex: 9 = September) Note: "—" Represents Internal Code

Month Code Key

Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	Ν	D



Maximum Ratings (@ $T_A = +25$ °C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	Conditions
Peak Pulse Power Dissipation	Ppp	70	W	8/20µs (Note 5)
Peak Pulse Current	IPP	7.5	Α	8/20µs (Note 5)
ESD Protection – Contact Discharge	V _{ESD_Contact}	±15	kV	Standard IEC 61000-4-2
ESD Protection – Air Discharge	V _{ESD Air}	±15	kV	Standard IEC 61000-4-2

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Thermal Resistance, Junction to Ambient Typical (Note 5)	$R_{ heta JA}$	+206	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +150	°C

Electrical Characteristics (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Conditions
Reverse Breakdown Voltage	V _{BR}	6	-	9	V	$I_R = 1mA$
Reverse Leakage Current (Note 6)	I _R	-	-	70	nA	V _R =3V
Dynamic Impedance	Rd		0.35	-	Ω	IPP = 1 to 5A, 8/20μs
Channel Input Capacitance	CIN	-	0.8	1.2	pF	$VIN = 0V$, $f = 1MHz$, $V_{OSC} = 30mV$

Notes:

- 5. Device mounted on FR-4 PCB pad layout (2oz copper) as shown on Diodes, Inc. suggested pad layout AP02001, which can be found on our website at http://www.diodes.com.
- 6. Short duration pulse test used to minimize self-heating effect.

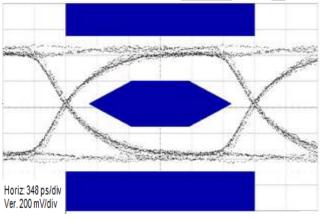


Figure 1. Eye diagram, board only (according to USB2.0 high speed specification)

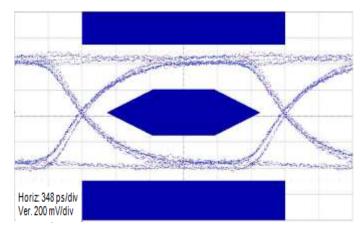
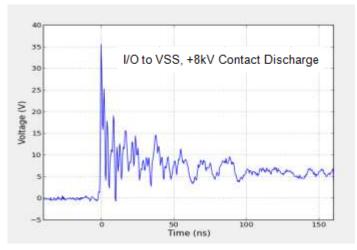


Figure 2. Eye diagram, board with DUSBULC6-CSP4 (according to USB2.0 high speed specification)



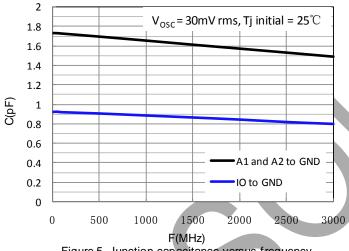


VSS to I/O, +8kV Contact Discharge

15
10
50
10
10
10
10
100
150
Time (ns)

Figure 3. ESD response to IEC 61000-4-2

Figure 4. ESD response to IEC 61000-4-2



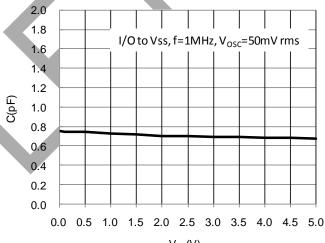
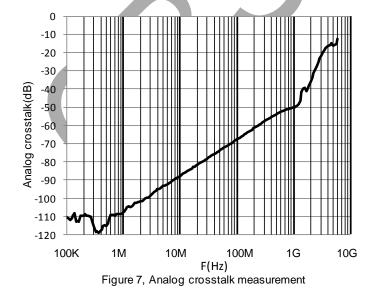


Figure 5. Junction capacitance versus frequency (typical values)

 $V_{\rm I/0}({\rm V})$ Figure 6. Junction Capacitance versus Input Voltage



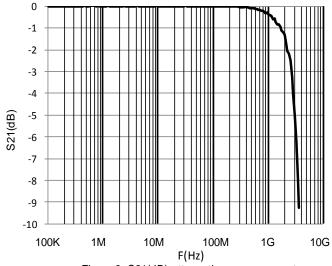


Figure 8, S21(dB) attenuation measurement



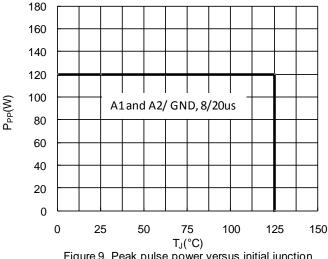


Figure 9. Peak pulse power versus initial junction temperature(maximum values, pulse 8/20us)

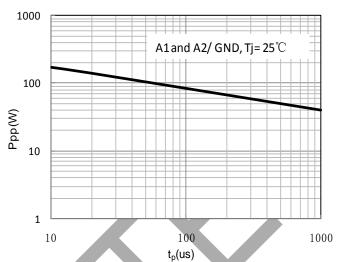


Figure 10. Peak pulse power versus exponential pulse duration(maximum values)

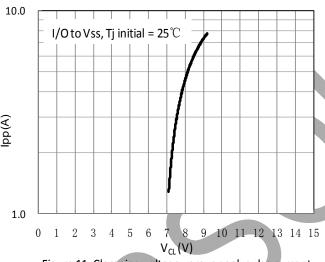


Figure 11. Clamping voltage versus peak pulse current (typical values, pulse 8/20us)

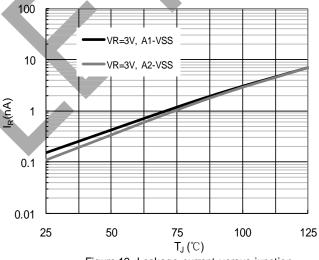
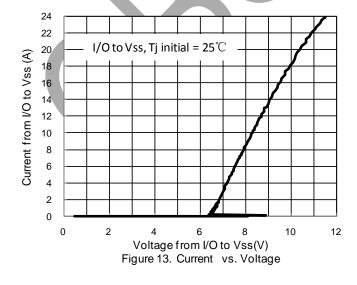


Figure 12. Leakage current versus junction temperature (typical values)



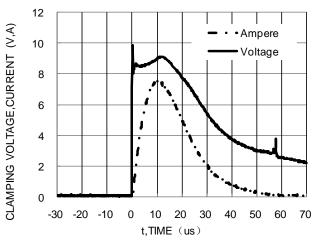
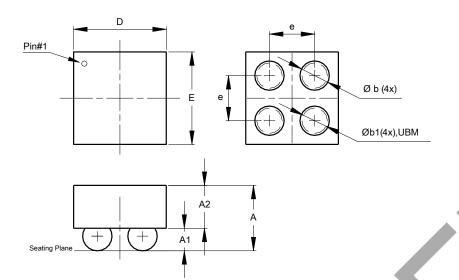


Figure 14. Waveform of Clamping Voltage, Current vs. Time(8/20us, I/O to Vss)



Package Outline Dimensions

Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.

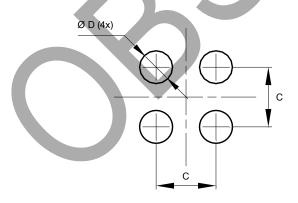


	W-WLB0808-4							
Dim	Min	Max	Тур					
Α	0.545	0.665	0.605					
A1	0.170	0.230	0.200					
A2	0.375	0.435	0.405					
b	0.240	0.280	0.260					
b1	0.235	0.245	0.240					
D	0.790	0.850	0.820					
E	0.790	0.850	0.820					
e	0.400 BSC							
All Dimensions in mm								

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.





Dimensions	Value (in mm)		
С	0.400		
D	0.220		



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